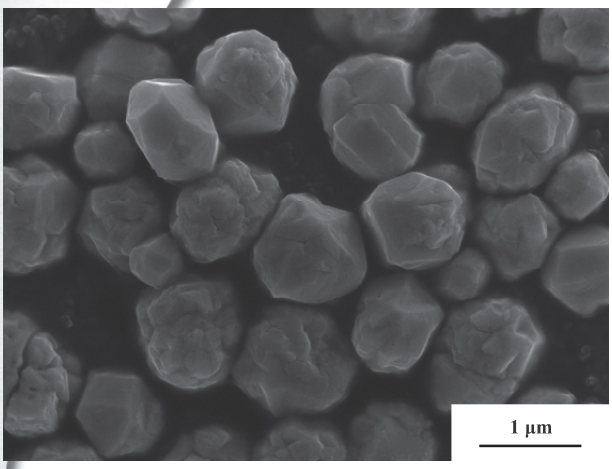
還元銅粉　Cu-C

Chemically Reduced Copper Powder [Cu-C]

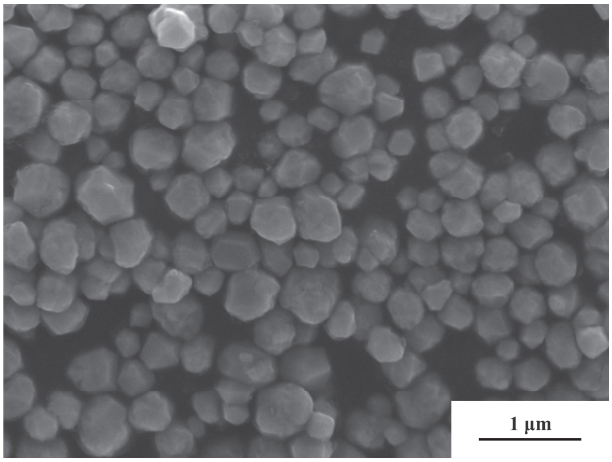
特長　*Advantages*

Cu-C は化学還元法で作製した銅粉末です。
低温焼成が可能で電子材料用途に最適です。
お客様の用途に応じた品種を取り揃えています。

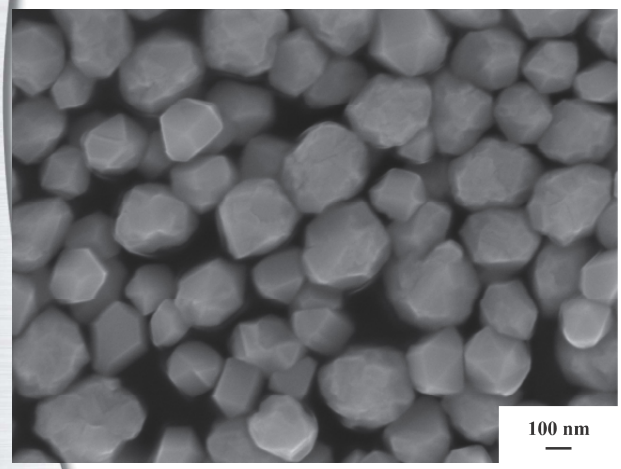
Cu-C is a copper powder manufactured by chemical reduction.
Cu-C powder enables low temperature baking and is ideal for various electronic materials.
We have a variety of products according to the customer's application.



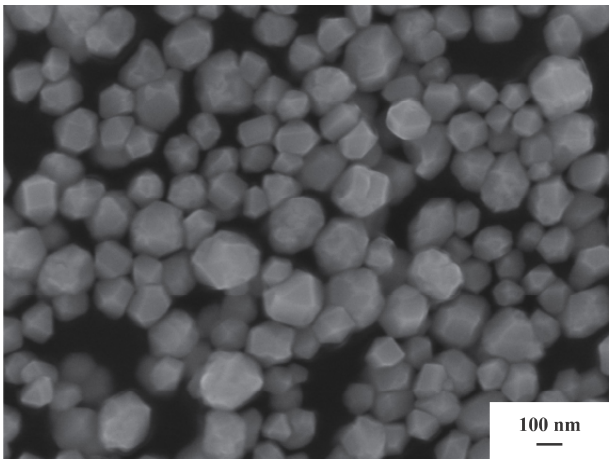
Cu-C 10 (SEM image)



Cu-C 20 (SEM image)



Cu-C 30 (SEM image)



Cu-C 40 (SEM image)

	品種 *Grade*	*BET* 比表面積 *Specific Surface Area by BET* (m^2/g)	*SEM*径 *Diameter* (µm)
Cu-C Copper Powder	*10*	*0.5 – 1.5*	*1.0*
	20	*1.5 – 2.5*	*0.4*
	30	*2.5 – 3.5*	*0.3*
	40	*3.5 – 4.5*	*0.2*

* 記載は全て代表値であり、保証値ではありません。また、事前の予告なく変更されることがあります。
**All figures shown above are typical values and are not guaranteed.*
Properties may be changed without advanced notice.

FUKUDA
FUKUDA METAL FOIL & POWDER CO.,LTD.
福田金属箔粉工業株式会社

福田金属箔粉工業株式会社 HP

CuC 製品紹介 HP

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